

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Micro RF Silicon, Inc.	01/03/2011
RECEIVING PARTY DATA	
Name:	Microsemi Corporation
Street Address:	2381 Morse Ave.
City:	Irvine
State/Country:	CALIFORNIA
Postal Code:	92614
PROPERTY NUMBERS Total: 5	
Property Type	Number
Patent Number:	7573329
Application Number:	12538428
Application Number:	12446311
Application Number:	61251586
Application Number:	61362349
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ATTORNEY DOCKET NUMBER:	MICRO RF SI TO MICROSEMI
NAME OF SUBMITTER:	Simon Kahn - Reg No 48249

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REEL: 025576 FRAME: 0642

Total Attachments: 3

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ASSIGNMENT

WHEREAS, Micro RF Silicon Inc., a Delaware corporation having offices at 2381 Morse Avenue, Irvine, California 92614 (hereinafter "ASSIGNOR"), represents and warrants that it is the sole owner of the entire right, title, and interest to certain new and useful improvements for which ASSIGNOR has filed, or has ownership of, the following United States issued Letters Patents, applications for Letters Patents in the United States, Provisional Patent Application, Other Patent Applications and Other Patents (hereinafter "the Patents and Patent Applications"):

<u>U.S. Patent No.</u>	<u>Issue Date</u>	<u>Title</u>
7,573,329	11 August, 2009	System and Method for IM3 Reduction and Cancellation in Amplifiers

<u>U.S. Application No.</u>	<u>Filing Date</u>	<u>Title</u>
12/538,428	10 August, 2009	System and Method for IM3 Reduction and Cancellation in Amplifiers
12/446,311	22 October, 2007	Inter-Stage Matching Network to Enhance Common Mode Stability

<u>Provisional Patent Application No.</u>	<u>Filing Date</u>	<u>Title</u>
61/251,586	14 October, 2009	RF Switchable Balun
61/362,349	8 July, 2010	Optimized Architecture for Coexistence of WAN and WIFI Radios

<u>Other Patent No.</u>	<u>Issue Date</u>	<u>Title</u>
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<u>Other Patent Application Nos.</u>	<u>Filing Date</u>	<u>Title</u>
PCT/US2007/080899	8 October, 2007	System and Method for On-Chip IM3 Reduction Over a Broad Range of Operating Powers
CN 200780044930.5	8 October, 2007	System and Method for On-Chip IM3 Reduction Over a Broad Range of Operating Powers
EP 07843972.6	8 October, 2007	System and Method for On-Chip IM3 Reduction Over a Broad Range of Operating Powers
IN 668/MUMNP/2009	8 October, 2007	System and Method for On-Chip IM3 Reduction Over a Broad Range of Operating Powers
JP 2009-631641	8 October, 2007	System and Method for On-Chip IM3 Reduction Over a Broad Range of Operating Powers

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KR 10-2009-7009077

8 October, 2007

System and Method for On-Chip IM3
Reduction Over a Broad Range of
Operating Powers

WHEREAS, Microsemi Corporation, a Delaware corporation having offices at 2381 Morse Ave., Irvine, California 92614 (hereinafter "ASSIGNEE") desires to purchase the entire right, title, and interest in and to the inventions disclosed in the Patents and Patent Applications;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) to ASSIGNOR, and other good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby further acknowledges that it has sold, assigned, and transferred, and by these presents does hereby sell, assign, and transfer, unto ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest throughout the world in, to, and under the said improvements, and the said Patents and Patent Applications and all Patents that may be granted thereon, and all provisional applications relating thereto, and all divisions, continuations, reissues, reexaminations, renewals, and extensions thereof, and all rights of priority under international Conventions and applications for Letters Patent that may hereafter be filed for said improvements or for the said Patents and Patent Applications in any country or countries foreign to the United States; and ASSIGNOR hereby authorizes and requests the Commissioner of Patents of the United States, and any Official of any country foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patents for said improvements and all Letters Patents resulting from the Patents and Patent Applications to ASSIGNEE, its successors, legal representatives, and assigns, in accordance with the terms of this Agreement.

ASSIGNOR does hereby sell, assign, transfer, and convey to ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the Letters Patents before or after issuance;

ASSIGNOR hereby covenants and agrees that it will communicate to ASSIGNEE, its successors, legal representatives, and assigns any facts known to ASSIGNOR respecting the Patents and Patent Applications immediately upon becoming aware of those facts, and that it will testify in any legal proceeding involving any of the Patents and Patent Applications, will sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths, and will generally do everything possible to aid ASSIGNEE, its successors, legal representatives, and assigns to obtain and enforce the Patents and Patent Applications in all countries.

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IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 3 day of
January, 2011.

Micro RF Silicon Inc.,

By: David Goren

Name Printed: David Goren

Title: Vice President, Legal